

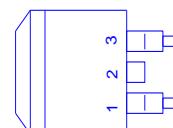
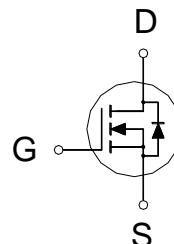
NIKO-SEM**N-Channel Enhancement Mode
Field Effect Transistor****PG1G10AS**

TO-263

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	2.1mΩ	197A



1. GATE
2. DRAIN
3. SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS		UNITS
Drain-Source Voltage		V_{DS}	100		V
Gate-Source Voltage		V_{GS}	± 20		V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	197		A
	$T_C = 100^\circ C$		139		
Pulsed Drain Current ¹		I_{DM}	800		
Avalanche Current		I_{AS}	48		
Avalanche Energy	$L = 1mH$	E_{AS}	1152		mJ
Power Dissipation	$T_C = 25^\circ C$	P_D	187		W
	$T_C = 100^\circ C$		93		
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 175		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		0.8	
Junction-to-Ambient	$R_{\theta JA}$		50	°C / W

¹Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ C$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	2.7	4	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 100V, V_{GS} = 0V$			1	
		$V_{DS} = 100V, V_{GS} = 0V, T_J = 125^\circ C$			100	μA

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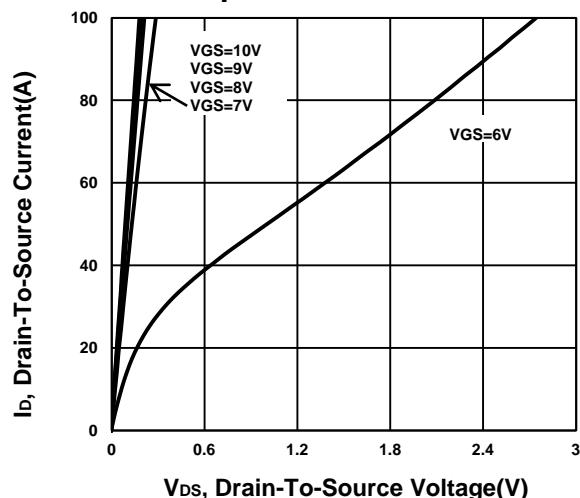
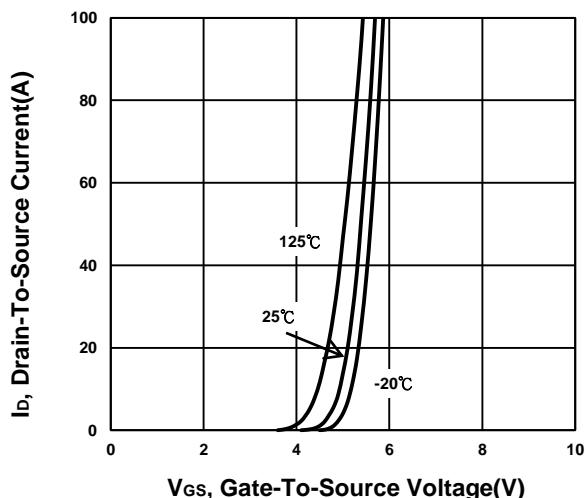
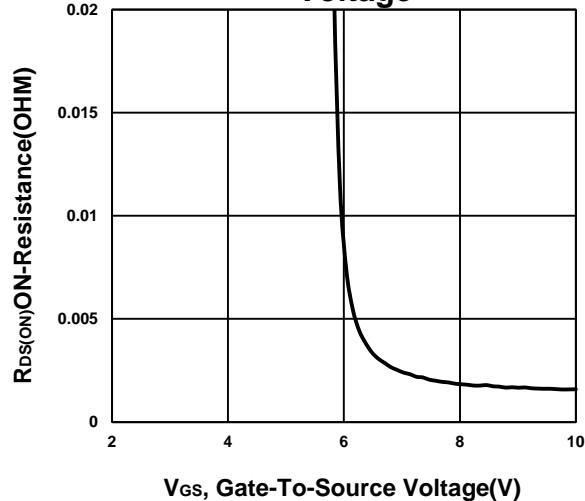
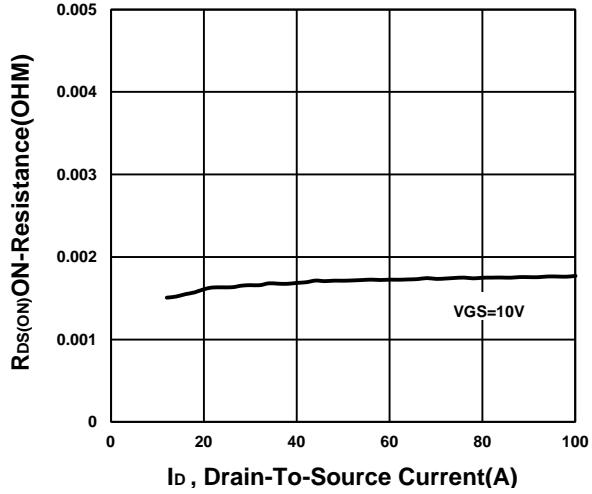
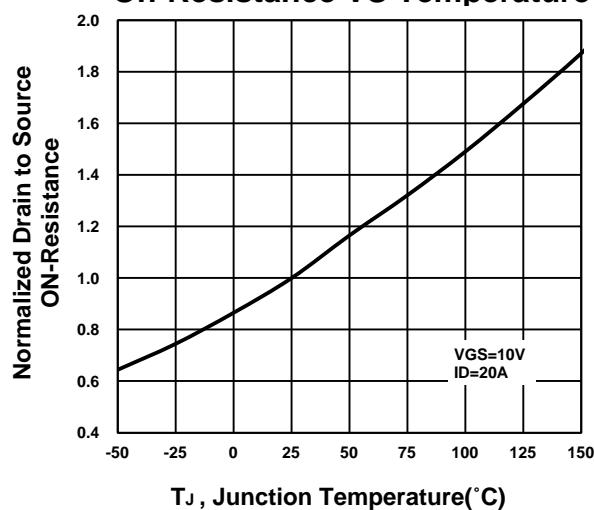
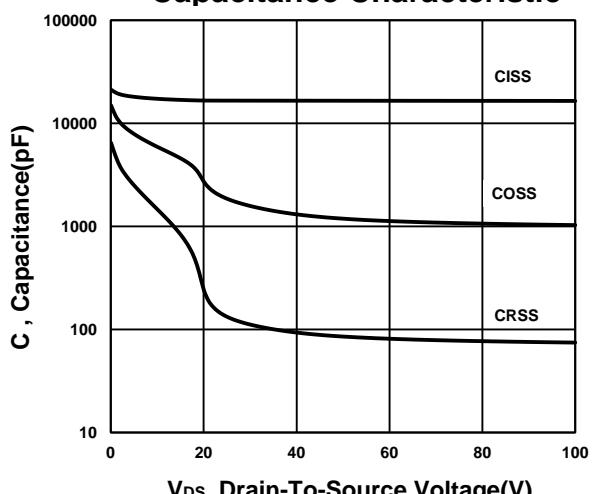
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 20A$		1.6	2.1	$m\Omega$
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 20A$		83		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 50V, f = 300KHz$		16287		pF
Output Capacitance	C_{oss}			1190		
Reverse Transfer Capacitance	C_{rss}			91		
Gate Resistance	R_g	$f = 1MHz$		4.2		Ω
Total Gate Charge ²	Q_g	$V_{GS} = 10V, V_{DS} = 50V, I_D = 20A$		280		nC
Gate-Source Charge ²	Q_{gs}			73		
Gate-Drain Charge ²	Q_{gd}			64		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DD} = 50V,$ $I_D \approx 20A, V_{GS} = 10V, R_{GEN} = 6\Omega$		36		nS
Rise Time ²	t_r			126		
Turn-Off Delay Time ²	$t_{d(off)}$			344		
Fall Time ²	t_f			159		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S				155	A
Forward Voltage ¹	V_{SD}	$I_F = 20A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	t_{rr}	$I_F = 20A, dI_F/dt = 100A/\mu s$		77		nS
Reverse Recovery Charge	Q_{rr}			206		nC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.

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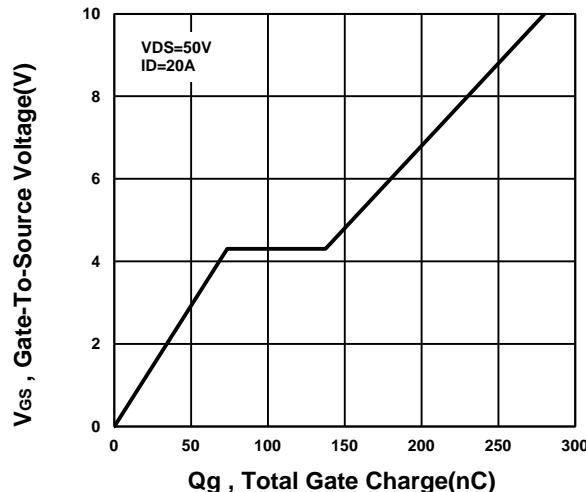
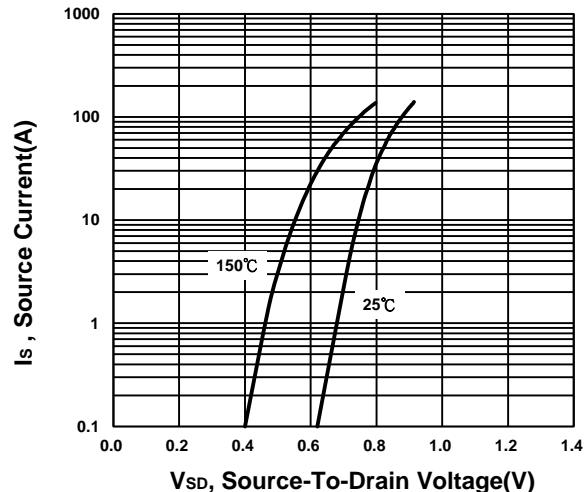
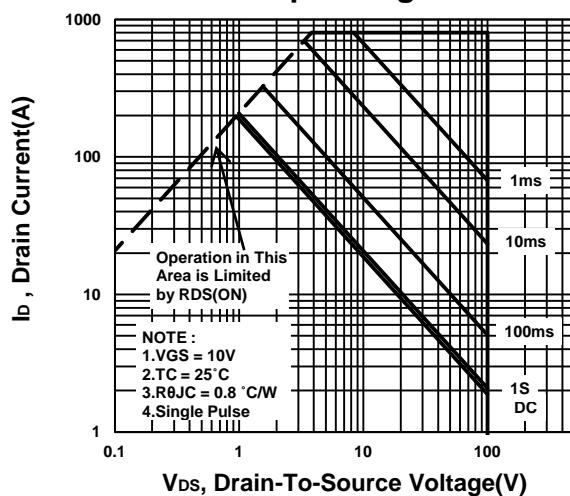
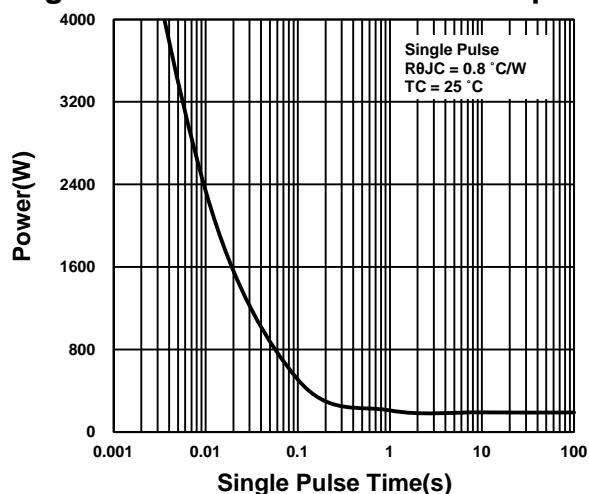
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Output Characteristics**Transfer Characteristics****On-Resistance VS Gate-To-Source Voltage****On-Resistance VS Drain Current****On-Resistance VS Temperature****Capacitance Characteristic**

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Gate charge Characteristics**Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**